

# LIS302ALB

## MEMS motion sensor 3-axis - ±2g analog output "piccolo" accelerometer

### Features

- 3.0V to 3.6V supply voltage
- ~2mW power consumption
- ±2g full-scale
- 3 acceleration channels plus multiplexed analog output
- Ratiometric output voltage
- Power down mode
- Embedded self test
- 10000g high shock survivability
- ECOPACK® RoHS and "Green" compliant (see Section 6)

## Description

The LIS302ALB is a miniaturized low-power three-axis linear accelerometer. It includes a sensing element and an IC interface to provide an analog signal to the external world.

The sensing element, capable of detecting the acceleration, is manufactured using a certicated process developed by ST to produce inction sensors and actuators in silicon.

The IC interface is manufactured using a CMOS process that allows to design a dedicated circuit which is trimmed to detter match the sensing element charac existics. The device can be operated from 2.16V to 3.6V.



The LIS302ALB has a full scale of  $\pm 2g$  and it is capable of measuring accelerations over a maximum bandwidth of 2.0kHz. The device bandwidth may be reduced by using external capacitances. A self-test capability allows the user to check the function include the sensor in the final application.

The device has three analog acceleration output plus an or readed multiplexer that allows to redirect the analog outputs onto a single pin for operation with a single channel A/D converter.

The LIS302ALB is available in plastic Thin Land Grid Array package (TLGA) and it is guaranteed to operate over an extended temperature range from -40°C to +85°C.

The LIS302ALB belongs to a family of products suitable for a variety of applications:

- Mobile terminals
- Gaming and Virtual Reality input devices
- Free-fall detection for data protection
- Antitheft systems and Inertial Navigation
- Appliance and Robotics.

### **Draer codes**

Part number	Temperature range, °C	Package	Packing
LIS302ALB	-40°C to +85°C	LGA-14	Tray
LIS302ALBTR	-40°C to +85°C	LGA-14	Tape & reel

Note: Tape & reel parts are compliant to International Standard EIA-481.

October 2006

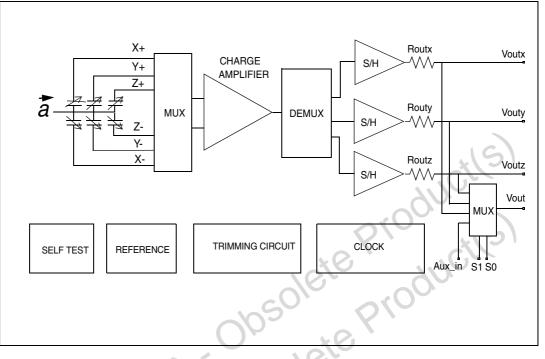
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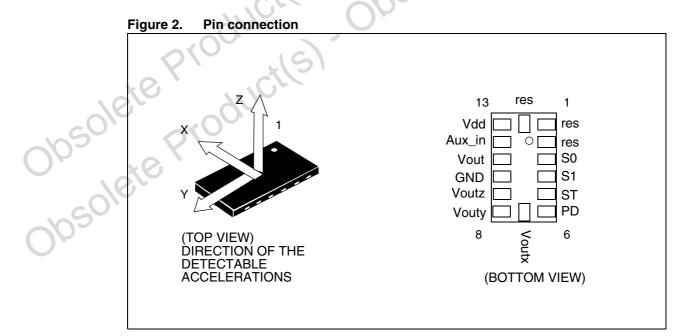


## 1 Block diagram





## 1.1 Pin description





1	Pin Name	Function	
L	Reserved	Connect to Vdd	
2	Reserved	Connect to Vdd	
3	S0	Mux selector 0 (Connect to Vdd or to GND)	
4	S1	Mux selector 1 (Connect to Vdd or to GND)	
5	ST	Self Test (Logic 0: normal mode; Logic 1: Self-test)	
6	PD	Power Down (Logic 0: normal mode; Logic 1: Power-Down mode)	
7	Voutx	Output Voltage X channel	
8	Vouty	Output Voltage Y channel	
9	Voutz	Output Voltage Z channel	
10	GND	0V supply	
11	Vout	Multiplexer output	
12	Aux_In	Auxiliary input	
13	Vdd	Power supply	
14	Reserved	Connect to Vdd	
		stoosolete	

Table 1. Pin description



## 2 Mechanical and electrical specifications

#### 2.1 Mechanical characteristics.

#### Table 2. Mechanical characteristics<sup>(1)</sup>

All parameters are specified @ Vdd =3.3V, T = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ. <sup>(2)</sup>	Max.	Unit
Ar	Acceleration range <sup>(3)</sup>			±2.0		g
So	Sensitivity <sup>(4)</sup>		0.145*Vdd <i>−</i> 5%	0.145*Vdd	0.145*Vdd + 5%	V/g
SoDr	Sensitivity change Vs Temperature	Delta from +25°C		±0.01		%/°C
Voff	Zero-g level <sup>(4)</sup>	T = 25°C	Vdd/2-6%	Vdd/2	Vdd/2+6%	V
OffDr	Zero-g level change Vs Temperature	Delta from +25°C		±0.5	,00	mg/°C
NL	Non Linearity <sup>(5)</sup>	Best fit straight line		±0.5		% FS
CrossAx	Cross-Axis <sup>(6)</sup>		X	<b>2</b> ±2		%
An	Acceleration Noise Density	Vdd=3.3V	coler	200	,0 <sup>0</sup> .	µg/ √Hz
		T = 25°C Vdd=3.3V X axis	+95	8	+200	mV
Vt	Self test output voltage change <sup>(7),(8)</sup>	T = 25°C Vdd=3.3V Y axis	<b>9</b> +95		+200	mV
Prod		T = 25°C Vdd=3.3V Z axis	+95		+200	mV
Fres	Sensing Element Resonant Frequency <sup>(9)</sup>	all axes	2.0			kHz
Тор	Operating Temperature Range		-40		+85	°C
Wh	Product Weight			30		mgram

1. The product is factory calibrated at 3.3V. The operational power supply range is specified in table 3. Since the device is ratiometric Voff, So and Vt parameters will vary with supply voltage.

2. Typical specifications are not guaranteed

3. Guaranteed by wafer level test and measurement of initial offset and sensitivity

4. Zero-g level and sensitivity are ratiometric to supply voltage

5. Guaranteed by design

6. Contribution to the measuring output of an inclination/acceleration along any perpendicular axis

7. Self test output voltage change" is defined as Vout(Vst=Logic1)-Vout(Vst=Logic0)

8. Self test output voltage change" varies cubically with supply voltage

9. Minimum resonance frequency Fres=2.0kHz. Sensor bandwidth= $1/(2^*\pi^*32k\Omega^*Cload)$ 



### 2.2 Electrical characteristics

## Table 3. Electrical characteristics<sup>(1)</sup>

All parameters are specified @ Vdd =3.3V, T=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур. <sup>(2)</sup>	Max.	Unit
Vdd	Supply Voltage		3.0	3.3	3.6	V
ldd	Supply Current	mean value PD pin connected to GND		0.65		mA
IddPdn	Supply Current in Power Down Mode	PD pin connected to Vdd		1		μA
Vst	Self Test Input	Logic 0 level at Vdd=3.3V	0		0.8	V
VSL	Sen lest input	Logic 1 level at Vdd=3.3V	2.0		Vdd	٧
Rout	Output impedance of Voutx, Vouty, Voutz			32	300	kΩ
Cload	Capacitive Load Drive for Voutx, Vouty, Voutz <sup>(3)</sup>		2.5	epro	Ċ	nF
Vs0	S0 Input	Logic 0 level at Vdd=3.3V	0		0.8	V
V 50	So input	Logic 1 level at Vdd=3.3V	2.0	50	Vdd	V
Vs1	S1 input	Logic 0 level at Vdd=3.3V	0		0.8	V
V31		Logic 1 level at Vdd=3.3V	2.0		Vdd	V
Rmux	Series resistance of multiplexer input Vs Vout	ct(S) 00	,010	1		kΩ
Cloadmux	Capacitive load drive for multiplexed output Vout	.15		10		pF
Ton	Turn-On Time at exit from Power Down mode	Cload in μF		160*Cload+0.3		ms
Тор	Operating Temperature Range		-40		+85	°C

1. The product is factory calibrated at 3.3V. For availability of different supply voltage in the maximum range [2.16V, 3.6V] contact factory

2. Typical specifications are not guaranteed

3. Minimum resonance frequency Fres=2.0kHz. Device bandwidth=1/( $2^{*}\pi^{*}32k\Omega^{*}Cload$ )



### 2.3 Absolute maximum ratings

Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Symbol	Ratings	Maximum Value	Unit
Vdd	Supply voltage	-0.3 to 6	V
Vin	Input Voltage on Any Control pin (PD, ST)	-0.3 to Vdd +0.3	V
V <sub>Aux_in</sub>	Aux_in Input Voltage	-0.3 to Vdd +0.3	V
^	Acceleration (Any axis Reward )(dd-2.2)()	3000g for 0.5 ms	2
A <sub>POW</sub>	Acceleration (Any axis, Powered, Vdd=3.3V)	10000g for 0.1 ms	-
٨		3000g for 0.5 ms	/
A <sub>UNP</sub>	Acceleration (Any axis, Not powered)	10000g for 0.1 ms	S
T <sub>STG</sub>	Storage Temperature Range	-40 to +150	°C
	165	2 (HBM)	KV
ESD	Electrostatic Discharge Protection	1.5 (CDM)	KV
	003	200 (MM)	V



This is a Mechanical Shock sensitive device, improper handling can cause permanent damages to the part



This is an ESD sensitive device, improper handling can cause permanent damages to the part

## 2.4 Terminology

**Sensitivity** describes the gain of the sensor and can be determined by applying 1g acceleration to it. As the sensor can measure DC accelerations this can be done easily by pointing the axis of interest towards the center of the earth, note the output value, rotate the sensor by 180 degrees (point to the sky) and note the output value again thus applying  $\pm 1g$  acceleration to the sensor. Subtracting the larger output value from the smaller one and dividing the result by 2 will give the actual sensitivity of the sensor. This value changes very little over temperature (see sensitivity change vs. temperature) and also very little over time. The Sensitivity Tolerance describes the range of Sensitivities of a large population of sensors.

**Zero-g level** describes the actual output signal if there is no acceleration present. A sensor in a steady state on a horizontal surface will measure 0g in X axis and 0g in Y axis whereas the Z axis will measure +1g. The output is ideally for a 3.3V powered sensor Vdd/2 = 1650mV. A deviation from ideal 0-g level (1650mV in this case) is called Zero-g offset. Offset of precise MEMS sensors is to some extend a result of stress to the sensor and therefore the offset can slightly change after mounting the sensor onto a printed circuit board or exposing it to extensive mechanical stress. Offset changes little over temperature - see "Zero-g level change vs. temperature" - the Zero-g level of an individual sensor is very stable



over lifetime. The Zero-g level tolerance describes the range of Zero-g levels of a population of sensors.

**Self Test** allows to check the sensor functionality without moving it. The Self Test function is off when the ST pin is connected to GND. When the ST pin is tied at Vdd an actuation force is applied to the sensor, simulating a definite input acceleration. In this case the sensor outputs will exhibit a voltage change in their DC levels which is related to the selected full scale and depending on the Supply Voltage through the device sensitivity. When ST is activated, the device output level is given by the algebraic sum of the signals produced by the acceleration acting on the sensor and by the electrostatic test-force. If the output signals change within the amplitude specified inside Table 2, than the sensor is working properly and the parameters of the interface chip are within the defined specification.

Output impedance describes the resistor inside the output stage of each channel. This resistor is part of a filter consisting of an external capacitor of at least 2.5nF and the internal resistor. Due to the resistor level, only small inexpensive external capacitors are needed to generate low corner frequencies. When interfacing with an ADC it is important to use high input impedance forms a corner frequency close to the resonance frequency. Note that the minimum load capacitance forms a corner frequency close to the resonance frequency of the sensor. In general the smallest possible bandwidth for a particular application should be chosen to get the best results.

### 3 Functionality

The LIS302ALB is an "piccolo" low-power, analog output three-axis linear accelerometer packaged in a LGA package. The complete device includes a sensing element and an IC interface able to take the information from the sensing element and to provide an analog signal to the external world. The sensor provides the three accelerations and one multiplexed analog output.

#### 3.1 Sensing element

A proprietary process is used to create a surface micro-machined accelerometer. The technology allows to carry out suspended silicon structures which are attached to the substrate in a few points called anchors and are free to move in the direction of the sensed acceleration. To be compatible with the traditional packaging techniques a cap is placed on top of the sensing element to avoid blocking the moving parts during the moulding phase of the plastic encapsulation.

When an acceleration is applied to the sensor the proof mass displaces from its nominal position, causing an imbalance in the capacitive half-bridge. This imbalance is measured using charge integration in response to a voltage pulse applied to the sense capacitor.

At steady state the nominal value of the capacitors are few pF and when an acceleration is applied the maximum variation of the capacitive load is in fF range.

#### 3.2 IC interface

The complete signal processing uses a fully differential structure, while the final stage converts the differential signal into a single-ended one to be compatible with the external world.

The first stage is a low-noise capacitive amplifier that implements a Correlated Double Sampling (CDS) at its output to cancel the offset and the 1/f noise. The produced signal is then sent to three different S&Hs, one for each channel, and made available to the outside.

The device provides an embedded multiplexer to allow the redirection of either the analog output signals Voutx, Vouty, and Voutz or of an auxiliary input signal onto a single pin for operation with a single channel A/D converter.

All the analog parameters (output offset voltage and sensitivity) are ratiometric to the voltage supply. Increasing or decreasing the voltage supply, the sensitivity and the offset will increase or decrease linearly. The feature provides the cancellation of the error related to the voltage supply along an analog to digital conversion chain.

The product is factory calibrated at 3.3V. For availability of different supply voltage in the maximum range [2.16V, 3.6V] contact factory

#### **3.3 Factory calibration**

The IC interface is factory calibrated for sensitivity (So) and Zero-g level (Voff). The trimming values are stored inside the device in a non volatile structure. Any time the device is turned on, the trimming parameters are downloaded into the registers to be employed during the normal operation. This allows the user to employ the device without further calibration.



## 4 Application hints

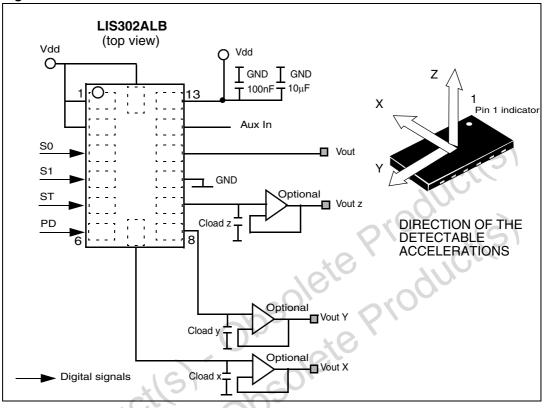


Figure 3. LIS302ALB electrical Connection

Power supply decoupling capacitors (100nF ceramic or polyester +  $10\mu$ F Aluminum) should be placed as near as possible to the device (common design practice).

The LIS302ALB allows to band limit Voutx, Vouty and Voutz through the use of external capacitors. The recommended frequency range spans from DC up to 2.0kHz. Capacitors must be added at output pins to implement low-pass filtering for antialiasing and noise reduction. The equation for the cut-off frequency ( $f_t$ ) of the external filters is:

$$f_{t} = \frac{1}{2\pi \cdot R_{out} \cdot C_{load}(x, y, z)}$$

Taking into account that the internal filtering resistor ( $R_{out}$ ) has a nominal value equal to  $32k\Omega$ , the equation for the external filter cut-off frequency may be simplified as follows:

$$f_{t} = \frac{5\mu F}{C_{load}(x, y, z)}[Hz]$$

The tolerance of the internal resistor can vary typically of  $\pm 20\%$  within its nominal value of  $32k\Omega$ ; thus the cut-off frequency will vary accordingly. A minimum capacitance of 2.5nF for  $C_{load}(x, y, z)$  is required in any case.

An external capacitor can be added to the Vout pin. Values below 10 pF are recommended.

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( <b>∧</b> , <b>y</b> ,∠)
Capacitor value
5 µF
0.5µF
250nF
100nF
50nF
25nF
10nF

Table 5.Filter capacitor selection, Cload (x,y,z)

#### Table 6. MUX I/O table

S1 pin	S0 pin	MUX status
0	0	Vout=Vout X
0	1	Vout=Vout Y
1	0	Vout=Vout Z
1	1	Vout=Aux_in

### 4.1 Soldering information

The LGA package is compliant with the ECOPACK, RoHs and "Green" standard.It is qualified for soldering heat resistance according to JEDEC J-STD-020C.

Pin1 indicator is electrically connected to pin 1. Leave pin 1 indicator unconnected during soldering. Land pattern and soldering recommendations are available at <u>www.st.com/mems</u>.

### 4.2 Output response vs. orientation

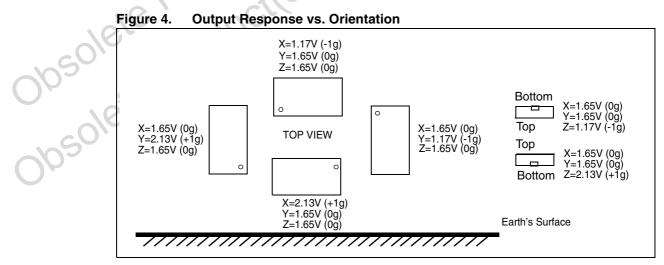


Figure 4 refers to LIS302ALB powered at 3.3V.



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#### **Typical performance characteristics** 5

#### Mechanical characteristics at 25°C 5.1

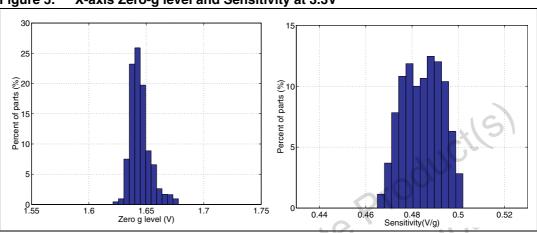
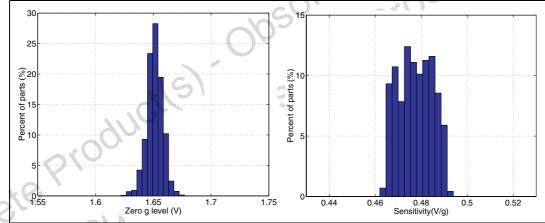
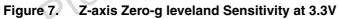
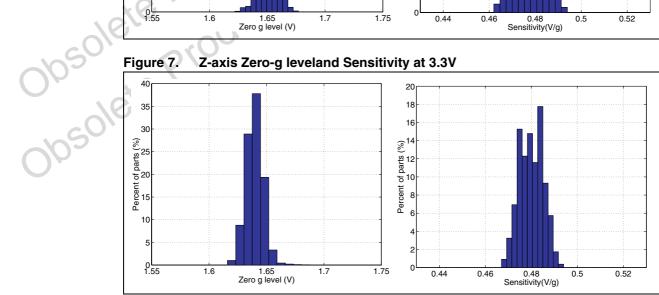


Figure 5. X-axis Zero-g level and Sensitivity at 3.3V

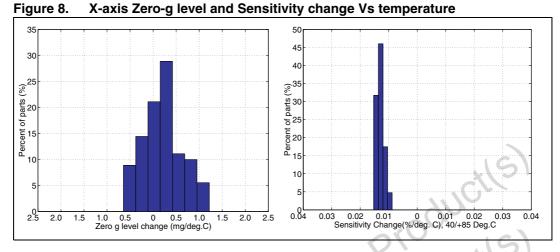
#### Figure 6. Y-axis Zero-g level and Sensitivity at 3.3V



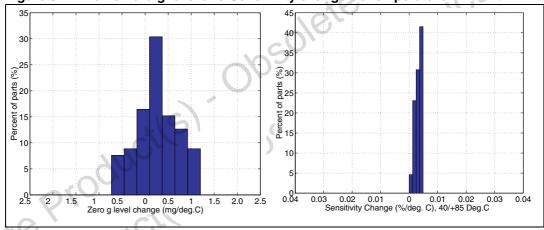




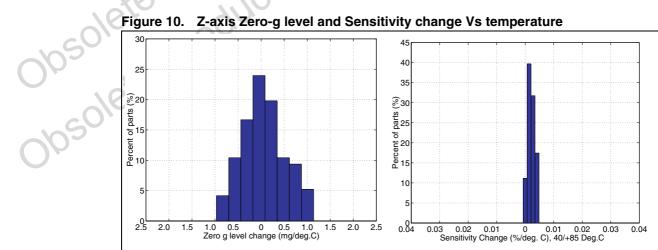
#### 5.2 Mechanical characteristics derived from measurement in the -40°C to +85°C temperature range









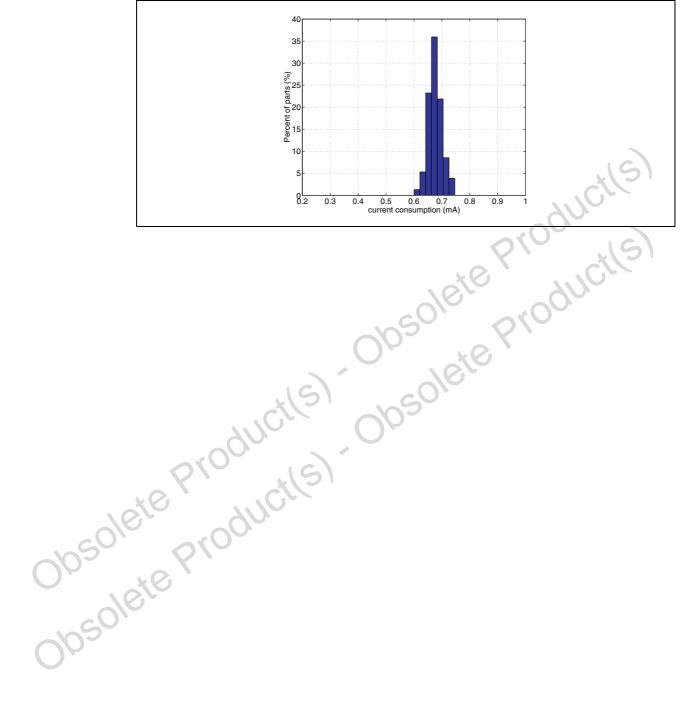




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### 5.3 Electrical characteristics at 25°C

#### Figure 11. Current consumption at 3.3V



## 6 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark.

ECOPACK specifications are available at: www.st.com.

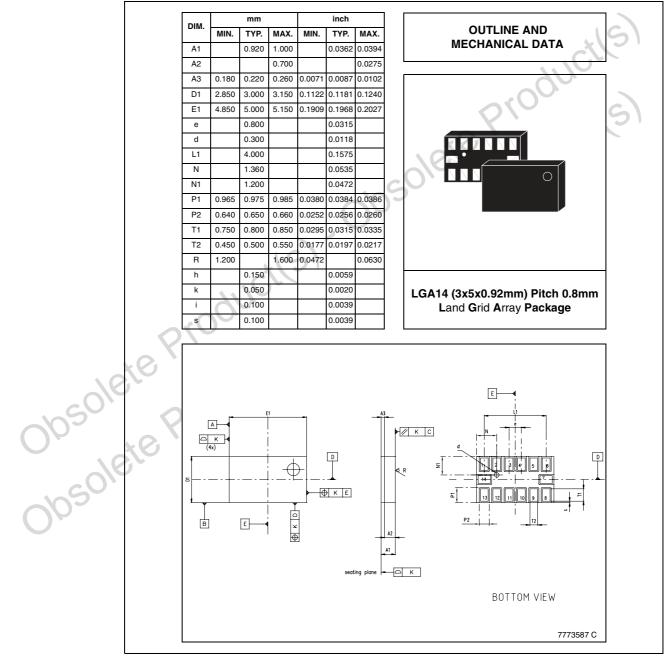


Figure 12. LGA 14: Mechanical Data & Package Dimensions

## 7 Revision history

#### Table 7.Document revision history

Date	Revision	Changes
03-Oct-2006	1	Initial release.

Obsolete Product(s) - Obsolete Product(s) Obsolete Product(s) - Obsolete Product(s)

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